RoHS

HALOGEN

**FREE** 



### Vishay General Semiconductor

## **Surface Mount Trench MOS Barrier Schottky Rectifier**



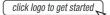


SlimSMA (DO-221AC)

Cathode Anode

#### **DESIGN SUPPORT TOOLS**

**Top View** 



**Bottom View** 



PRIMARY CHARACTERISTICS			
I <sub>F(AV)</sub>	5.0 A		
V <sub>RRM</sub>	60 V		
I <sub>FSM</sub>	100 A		
V <sub>F</sub> at I <sub>F</sub> = 5.0 A	0.48 V		
T <sub>J</sub> max.	150 °C		
Package	SlimSMA (DO-221AC)		
Circuit configuration	Single		

#### **FEATURES**

- Very low profile typical height of 0.95 mm
- · Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### TYPICAL APPLICATIONS

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

#### **MECHANICAL DATA**

Case: SlimSMA (DO-221AC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3\_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified

("\_X" denotes revision code e.g. A, B,....)

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD22-B102

M3 suffix meets JESD 201 class 1A whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	VSSAF56	UNIT	
Device marking code		V56		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	60	V	
Maximum DC forward current	I <sub>F</sub> <sup>(1)</sup>	5.0	Α	
Maximum DC forward current	I <sub>F</sub> <sup>(2)</sup>	2.6		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	I <sub>FSM</sub> 100		
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-40 to +150	°C	

#### Notes

- (1) Mounted on 30 mm x 30 mm pad areas, 2 oz. FR4 PCB
- (2) Free air, mounted on recommended copper pad area



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 2.5 A	- T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.47	-	V
	$I_F = 5.0 \text{ A}$			0.54	0.62	
	I <sub>F</sub> = 2.5 A	T <sub>A</sub> = 125 °C		0.38	=	
	I <sub>F</sub> = 5.0 A			0.48	0.56	
Reverse current	V <sub>R</sub> = 60 V	T <sub>A</sub> = 25 °C T <sub>A</sub> = 125 °C	I <sub>R</sub> <sup>(2)</sup>	-	0.4	- mA
	v <sub>R</sub> = 60 v	T <sub>A</sub> = 125 °C		4.5	15	
Typical junction capacitance	4.0 V, 1 MHz		CJ	540	-	pF

#### **Notes**

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: pulse width  $\leq 5$  ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise specified)				
PARAMETER	VSSAF56	UNIT		
Typical thermal resistance	R <sub>0JA</sub> (1)	115	°C/W	
	R <sub>0JM</sub> (2)	12		

#### **Notes**

 $^{(1)}$  Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient

(2) Mounted on 30 mm x 30 mm pad areas, 2 oz. FR4 PCB;  $R_{\theta JM}$  - junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
VSSAF56-M3/6A	0.032	6A	3500	7" diameter plastic tape and reel	
VSSAF56-M3/6B	0.032	6B	14 000	13" diameter plastic tape and reel	
VSSAF56HM3_A/H (1)	0.032	Н	3500	7" diameter plastic tape and reel	
VSSAF56HM3_A/I (1)	0.032	I	14 000	13" diameter plastic tape and reel	

#### Note

(1) AEC-Q101 qualified

## **RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25$ °C unless otherwise specified)

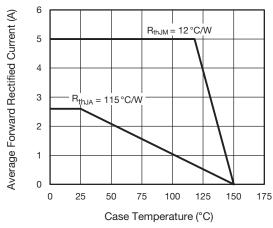


Fig. 1 - Maximum Forward Currernt Derating Curve

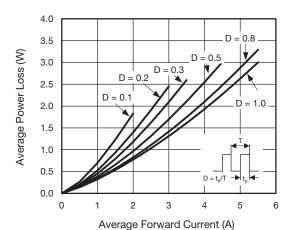


Fig. 2 - Average Power Loss Characteristics



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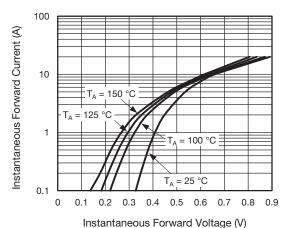


Fig. 3 - Typical Instantaneous Forward Characteristics

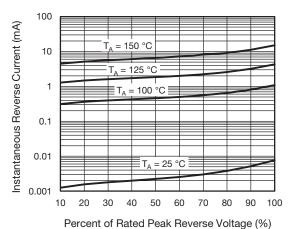


Fig. 4 - Typical Reverse Leakage Characteristics

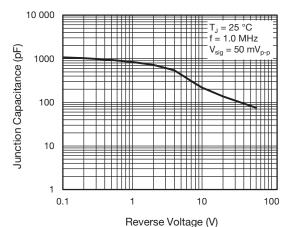


Fig. 5 - Typical Junction Capacitance

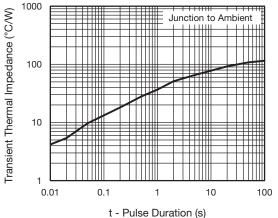


Fig. 6 - Typical Transient Thermal Impedance

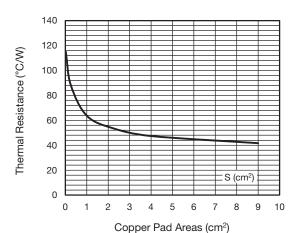


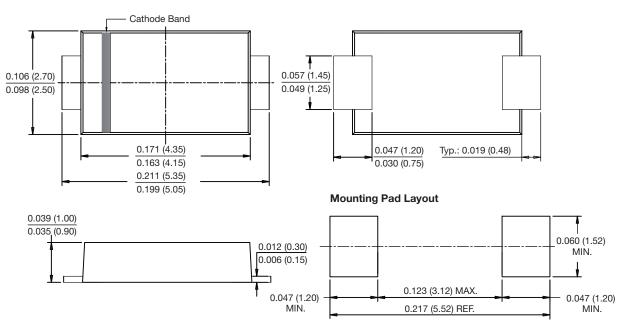
Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas



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### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

#### SlimSMA (DO-221AC)





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